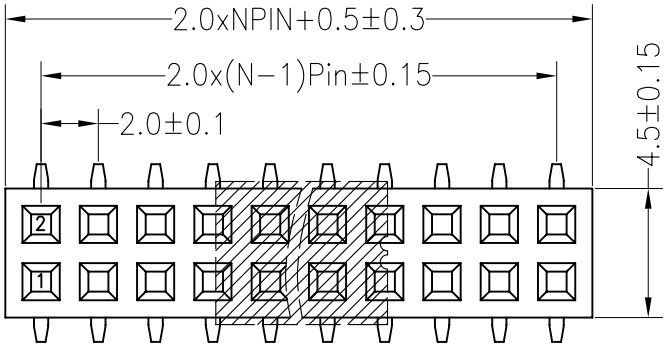
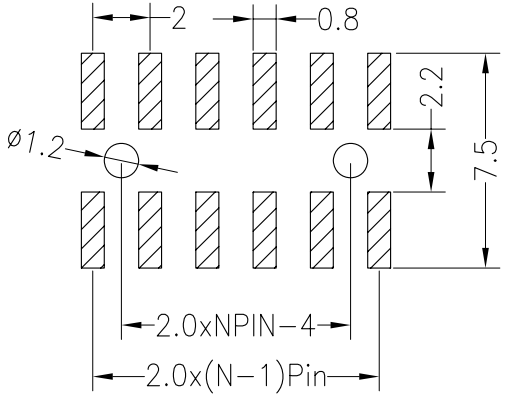
HSF RoHS FILE NO:E362810

SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA9T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



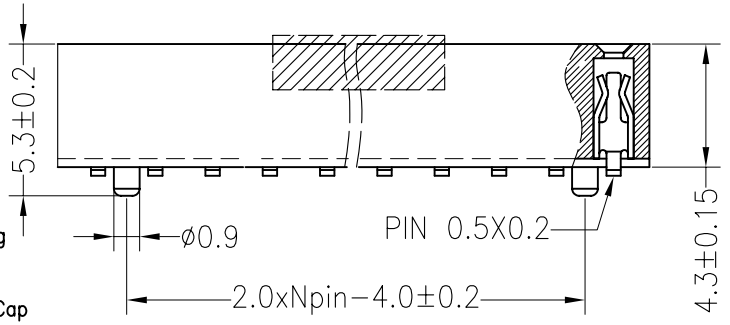
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

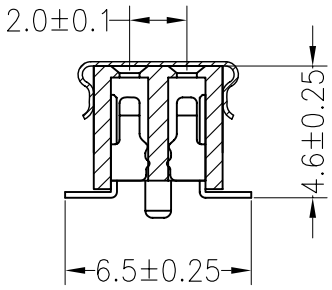


Ordering Information

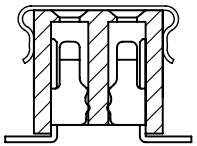
2343 02 XX X X XX M U X 03

- XX: No.of Pins Per Row 2*40
- X: Insulator Material Option
  - A=BK−PBT
  - B=BK−PA66
  - C=BK−PA6T
  - D=BK−PA46
  - E=BK−PA9T
  - F=BK−LCP
- X: Post
  - W=With Post
  - N=W/O Post
- XX: Contact Plating
  - G1:Gold Flash
  - G2:1.5U" Gold
  - G3:2U" Gold
  - G4:3U" Gold
  - G5:5U" Gold
  - S0:Gold Flash/Tin
  - SN:Tin
- X: Packing
  - 0=PE Bag
  - A=Tray
  - T=Tube
  - P=Tube+Cap
  - R=Reel+Cap
  - M=Reel+Mylar





W= With Post



N= W/O Post

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.07.23	NEW DRAWING	

OPERATION		DRAW	Liu Miao	12.07.23	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	2343-02XXXXXXMUX03
TITLE:	2.0PF H4.3mm 2xNpin SMT W4.50 夹持盖